SONY

CXA1737R

AFM Stereo Signal Processor for 8 mm VCR

Description

The CXA1737R is a bipolar IC designed as an AFM stereo signal processor for 8mm VCR.

All functions necessary for AFM stereo are concentrated onto a single 64-pin LQFP.

Features

- Low supply voltage (3.15V) design
- Low power consumption (Vcc = 3.15V)
    - Recording: 150mW
    - Playback: 240mW
- Built-in BPF (1.5MHz, 1.7MHz)
- Supports NTSC and PAL
- Enables both parallel and 3-line serial mode control
- Supports electronic volume (EVR) control

Absolute Maximum Ratings

- Supply voltage V_{CC} 5.25   V
- Operating temperature T_{opr} −20 to +75   ℃
- Storage temperature T_{stg} −65 to +150   ℃
- Allowable power dissipation
                                        P_D 1500   mW

Operating Conditions

- Recommended supply voltage
                              V_{CC} 3.15   V
                              $V_{CC}H$ 4.75   V
- Supply voltage range V_{CC} 3 to 5.25   V
                              $V_{CC}H$ 4.5 to 5.25   V
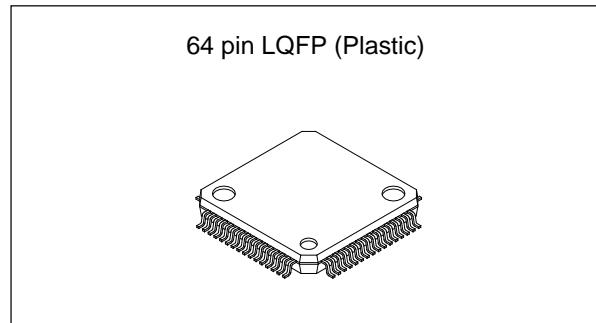
64 pin LQFP (Plastic)

Structure

Bipolar silicon monolithic IC

Applications

8mm VCRs

E96Z11A77

Block Diagram

Pin Description (Vcc1, Vcc2 = 3.15V, VccH = 4.75V, Ta = 27°C)

Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
1	ALCDET	—	—		ALC time constant pin. ALC is OFF when this pin is low.
2	LINEIN R	1.23V	Reference input −38dBm *1		Line input pin. Standard input level: −38dBm. This pin has a small input signal level and high input impedance. Therefore, be careful not to cause cross talk with other signals.
3	FADE	See Graph 1.	—		EVR control pin for fader. 0 to 0.5V with fixed gain. Increasing the applied voltage lowers the gain and causes the fader to operate.
4	MICIN R	1.23V	Reference input −38dBm *1		Microphone input pin. Standard input level: −38dBm. This pin has a small input signal level and high input impedance. Therefore, be careful not to cause cross talk with other signals.
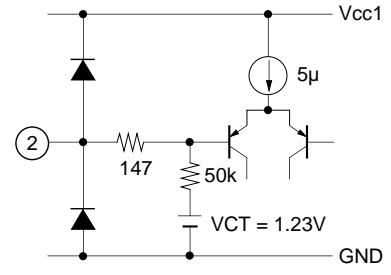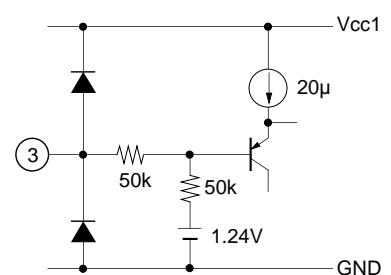
*1 0dBm = 2.19Vp-p

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
5	IFDC R	1.90V	—		DC monitor pin of Rch signal path.
6	IREF	1.17V	—		Pin for generating the reference current. Connect a 47kΩ external resistor to GND. Be careful not to cause pin cross talk.
7	RFDC L	1.91V	—		DC monitor pin of Lch signal path.
8	RFDC R	1.91V	—		DC monitor pin of Rch signal path.
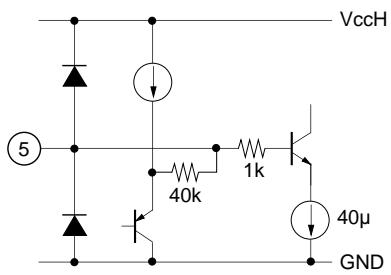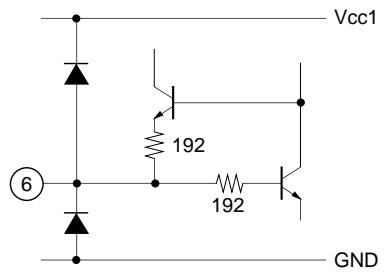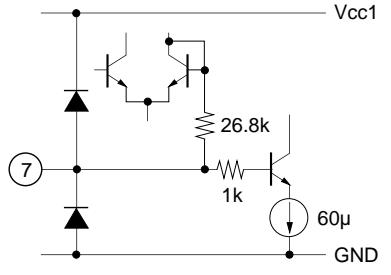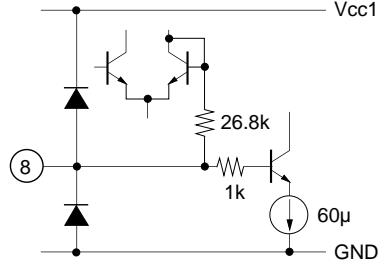
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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
9	IFDC L	1.90V	—	VccH / 40k / 1k / 40μ / GND / (9)	DC monitor pin of Lch signal path.
10	GND1	0V*1	—	—	Audio system GND pin.
11	WEIGHT R	1.23V	—	Vcc1 / 5μ / 4.7k / GND / (11)	NR WEIGHT time constant pin.
12	NRDC R	1.73V	—	Vcc1 / 147 / 1k / 5μ / GND / (12)	DC offset cancel pin of NR block.
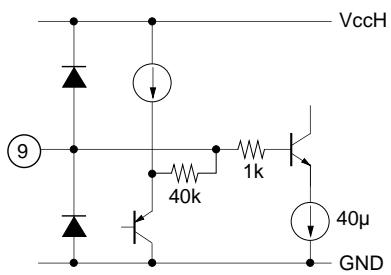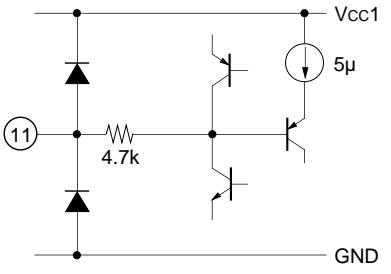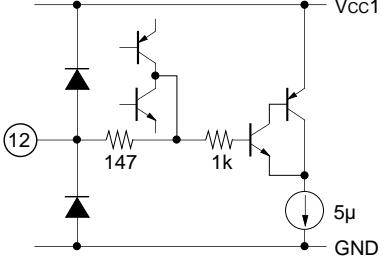
*1 Externally applied voltage

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
13	TCH R	0.56V	—		NR attack/ recovery time constant pins.
14	TC R	1.19V	—		
15	MONI R	1.89V	Reference output −15dBm *1		Pin for monitoring the signal before modulation during recording and after demodulation during playback of Rch.
16	DEVADJ R	See Graph 4.	—		Deviation adjusting pin. The variable width is from 0 to Vcc.
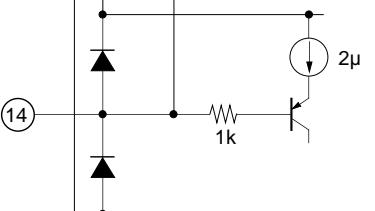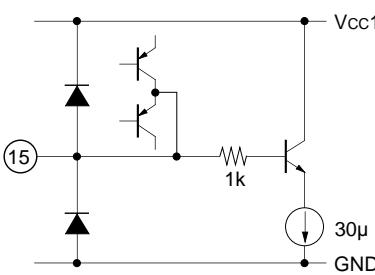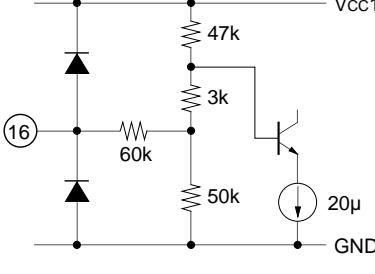
*1 0dBm = 2.19Vp-p

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
17	SI/ $\overline{PA}$ (SP/ $\overline{LP}$)	—	—		Serial/ parallel (SP/ $\overline{LP}$) mode switching pin. When this pin is 4.3V or more, the IC operates in serial control mode and mode control for the IC is performed by CS, CK and SI of Pins 58, 59 and 60. When this pin is 3.5V or less, the IC operates in parallel control mode as follows. 	L (0 to 1V) → LP; H (2 to 3.5V) or OPEN → SP
18	MONO DET	2.47V	—		MONO DET time constant pin.
19	PLLLPF R	—	—		PLL time constant pin. Since this pin has a small attraction and discharge current, signals should be received with high impedance when monitoring this pin. Also, be careful not to cause pin cross talk.

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
20	MONOOUT	—	—		MONODET discrimination output pin. This pin is open collector, and it is pulled up to Vcc with 100kΩ resistor. During parallel mode, this pin is also recording bilingual control input pin. • Specification for parallel CTL During recording: Bilingual recording mode when this pin is set to low (0 to 1 V) during low of Pin 32 (REC MONO mode). During playback: Outputs MONO discrimination result. Open for MONO; Low for others. • Specification for serial CTL See Mode Control Tables of 3) SO control mode table.
21	RFAGCTC	2.48V	—		RFAGC time constant pin.
22	PBRFIN	—	Reference input AFM 15mVp-p (1.5MHz)		Input pin for PB RF signal. The reference input level is approximately 200mVp-p (Y + C + AFM). Note that the reference input level of AFM 1.5MHz component is 15mVp-p.

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
23	BPFMONI	During 1.5M BPF monitoring 1.09V During 1.7M BPF monitoring 2.51V	Reference output 1.5M BPF = 180mVp-p 1.7M BPF = 190mVp-p		This pin is for measurement which monitors the BPF output. For monitoring 1.5M BPF characteristics, connect 4.7kΩ resistor to GND. For monitoring 1.7M BPF characteristics, connect 4.7kΩ resistor to Vcc.
24	RECFMOUT	0.96V	1.5M + 1.7M reference output		Recording FM modulated output pin. Reference output is 220mVp-p for 1.5M component; 175mVp-p for 1.7M component.
25	VCT	1.89V	—		IC internal bias pin. Connect a decoupling capacitor.
26	BPF ADJ	See Graph 2.	—		Pin for varying the BPF fo. The variable width is 0 to Vcc.

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
27	MUTETC	2.43V	—		Time constant pin for determining the MUTE OFF delay time. MUTE ON when drop out (T) continues approximately 1ms (during 680pF externally).
28	NTSC/$\overline{\text{PAL}}$	—	—		NTSC/$\overline{\text{PAL}}$ switching pin during parallel mode. L (0 to 1V) → PAL H (2V to Vcc) → NTSC
29	FSCIN	1.68V	Reference input 200mVp-p		fsc input pin. The input level is approximately 200mVp-p. During NTSC: 3.579545MHz During PAL: 4.433619MHz
30	NC	—	—		—
31	RFSWP	—	Reference input 30Hz		RFSWP input pin. H (2V to Vcc) L (0 to 1V) 30Hz
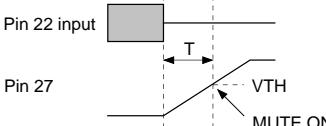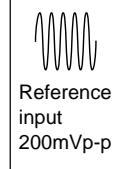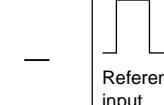
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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
32	MATRIX CTL	—	—		MATRIX control input pin during parallel mode.
33	OUTSEL CTL (P.SAVE)	—	—		OUTPUT SEL control input pin during parallel mode.
34	PLLLPF L	1.75V	—		PLL time constant pin. Since this pin has a small attraction and discharge current, signals should be received with high impedance when monitoring this pin. Also, be careful not to cause pin cross talk.
35	NC	—	—		—
36	DEVADJ L	See Graph 3.	—		Deviation adjusting pin. The variable width is from 0 to Vcc.

Pin 32 table:

Pin 32	During parallel		During serial
	REC	PB	
L (0 to 0.7V)	MONO	Bilingual/ MONO Auto	REC MONO
M (1.3 to 1.7V) or OPEN	STEREO	STEREO/ MONO Auto	—
H (2.3V to Vcc)	STEREO	STEREO	—

Pin 33 table:

Pin 33	Mode
L (0 to 0.7V)	Lch/ Rch
M (1.3 to 1.7V) or OPEN	Lch/ Rch (Main)
H (2.3 to 3.5V)	Lch/ Rch (SUB)
H2 (4.3V to VccH)	Power save 1.5M BPF through

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
37	MONI L	1.88V	Reference output −15dBm *1		Pin for monitoring the signal before modulation during recording and after demodulation during playback of Lch.
38	TC L	1.19V	—		NR attack/ recovery time constant pins.
39	TCH L	0.56V	—		
40	GND2	0V*2	—	—	RF system GND pin.
41	NRDC L	1.74V	—		NR block DC offset cancel pin.

*1 0dBm = 2.19Vp-p
*2 Externally applied voltage

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
42	WEIGHT L	1.23V	—		NR WEIGHT time constant pin.
43	VCTH	1.89V	—		RF system reference bias pin. Connect a decoupling capacitor.
44	SHTC L	1.89V	—		S/H time constant pin.
45	NC	—	—	—	—
46	SHTC R	1.89V	—		S/H time constant pin.
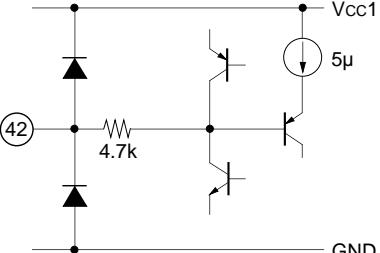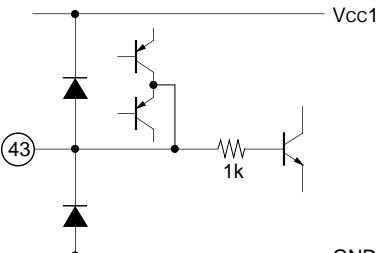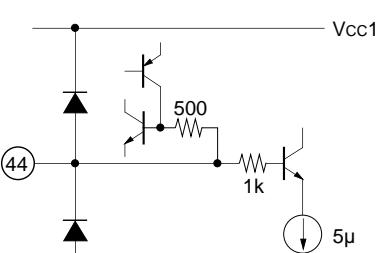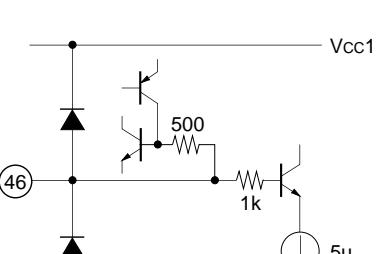
Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
47	DC R	1.92V	—		Rch DC check pin. Be careful not to cause pin cross talk.
48	MUTE ON/ OFF	—	—		Mute control pin. L (0 to 1V) → MUTE OFF H (2V to Vcc) or OPEN → MUTE ON Mute control is possible during both serial and parallel modes.
49	LINE OUT L	2.04V	Reference output −7dBm *1		LINEOUT pin. Set the load to 47kΩ or more.
50	EPOUT L	2.04V	Reference output −7dBm *1		EPOUT pin. This pin can drive a load of 120Ω.
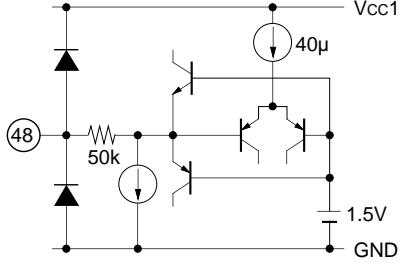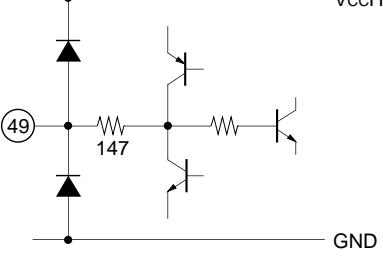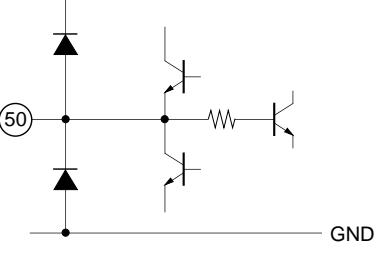
*1 0dBm = 2.19Vp-p

Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
51	GNDH	0V*2	—	—	Output buffer system GND pin.
52	EPLINEOUT R	2.04V	Reference output −7dBm *1		LINE/ EPOUT pin. This pin can drive a load of 120Ω.
53	MUTEOUT	0V	—		MUTEOUT pin. This pin outputs current during muting and power ON/OFF to operate the external SW Tr.
54	VccH	4.75V*2	—	—	Output buffer system power supply pin.
55	MIXOUT	2.06V	Reference output −7dBm *1		MIXOUT pin. Set the load to 47kΩ or more.
56	Vcc2	3.15V*2	—	—	RF system power supply pin.
57	PMUTETC	4.70V	—		Time constant pin for deciding the power ON/OFF mute time.
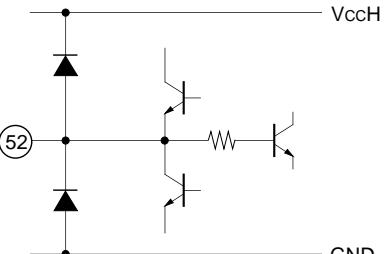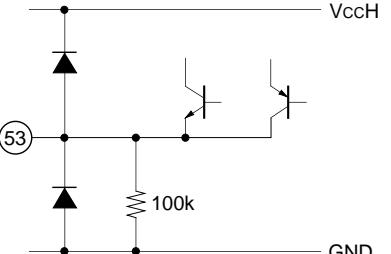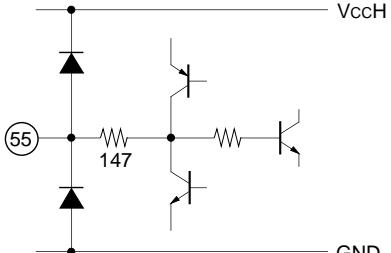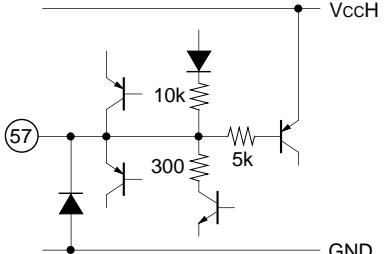
*1 0dBm = 2.19Vp-p
*2 Externally applied voltage

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
58	MIC/ $\overline{\text{LINE}}$ (CS)	—	—		MIC/ $\overline{\text{LINE}}$ switching pin during parallel mode. L (0 to 1V) or OPEN → LINE H (2V to Vcc) → MIC CS input pin during serial mode.
59	$\overline{\text{REC}}$/ PB (CK)	—	—		$\overline{\text{REC}}$/ PB switching pin during parallel mode. L (0 to 1V) or OPEN → REC H (2V to Vcc) → PB CK input pin during serial mode.
60	LINE MIX ON/ $\overline{\text{OFF}}$ (SI)	—	—		LINE OUT MIX ON/ $\overline{\text{OFF}}$ switching pin during parallel mode. L (0 to 1V) or OPEN → MIX OFF H (2V to Vcc) → MIX ON SI input pin during serial mode.
61	VCT5	2.00V	—		IC internal bias pin. Connect a decoupling capacitor.

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Pin No.	Symbol	Pin voltage		Equivalent circuit	Description
		DC	AC		
62	MICIN L	1.23V	Reference input −38dBm *1	Vcc1, 62, 147, 50k, 5μ, VCT = 1.23V, GND	Microphone input pin. Standard input level: −38dBm. This pin has a small input signal level and high input impedance. Therefore, be careful not to cause cross talk with other signals.
63	Vcc1	3.15V*2	—	—	Audio system power supply pin.
64	LINEIN L	1.23V	Reference input −38dBm *1	Vcc1, 64, 147, 50k, 5μ, VCT = 1.23V, GND	Line input pin. Standard input level: −38dBm. This pin has a small input signal level and high input impedance. Therefore, be careful note to cause cross talk with other signals.
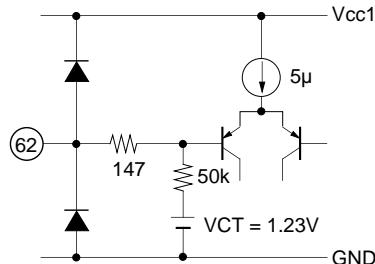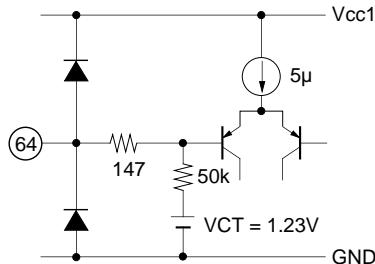
*1 0dBm = 2.19Vp-p
*2 Externally applied voltage

Electrical Characteristics   (Vcc1, Vcc2 = 3.15V, VccH = 4.75V, Ta = 27°C)   (Unless otherwise specified, SW 1, 2, 3, 4, 16, 22, 23, 26, 29, 31, 36, 44, 46, 52, 62, and 64 are b.)

No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measurement point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
1	Current consumption 1 during recording Vcc1 + Vcc2 systems	IREC1							—		A	I1	During serial mode no signal	25	35	45	mA
2	Current consumption 2 during recording VccH system	IREC2							—		A	I2	During serial mode no signal	6	9	12	mA
3	Current consumption 1 during playback Vcc1 + Vcc2 systems	IPB1							—		B	I1	During serial mode no signal	47	63	79	mA
4	Current consumption 2 during playback VccH system	IPB2							—		B	I2	During serial mode no signal	6	9	12	mA
5	MIC IN reference output level	VLNOL VLNOR	SG62 SG4	−38dBm	1kHz				—	4, 62 = a	A	Pin 49 Pin 52		−8	−7	−6	dBm
6	MIC IN reference output level R/L difference	BAC1	SG62 SG4	−38dBm	1kHz				—	4, 62 = a	A	—	VLNOR/VLNOL	−0.55	0	+0.55	dB
7	MIC IN reference output distortion factor	HLNOL HLNOR	SG62 SG4	−38dBm	1kHz				—	4, 62 = a	A	Pin 49 Pin 52	Measure the THD to the 10th	—	0.02	0.1	%
8	MIC IN output noise	NLNL NLNR							—		A	Pin 49 Pin 52	A weight	—	−72	−70	dBm
9	LINE IN reference output level	VLNOLL VLNOLR	SG64 SG2	−38dBm	1kHz				—	2, 64 = a	G	Pin 49 Pin 52		−8	−7	−6	dBm
10	LINE IN reference output level R/L difference	BACL1	SG64 SG2	−38dBm	1kHz				—	2, 64 = a	G	—	VLNOLR/VLNOLL	−0.55	0	+0.55	dB
11	LINE IN reference output distortion factor	HLNOLL HLNOLR	SG64 SG2	−38dBm	1kHz				—	2, 64 = a	G	Pin 49 Pin 52	Measure the THD to the 10th	—	0.02	0.1	%
12	LINE IN output noise	NLNLL NLNLR							—		G	Pin 49 Pin 52	A weight	—	−72	−70	dBm
13	ALC level 1 (REF + 20dB)	VALCL20 VALCR20	SG62 SG4	−18dBm	1kHz				—	4, 62 = a	A	Pin 49 Pin 52		−5.0	−2.1	+1.0	dBm

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No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measurement point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
14	ALC level 2 (REF + 36dB)	VALCL36 VALCR36	SG62 SG4	−2dBm	1kHz				—	4, 62 = a	A	Pin 49 Pin 52		−3.0	−1.9	+3.0	dBm
15	ALC maximum input distortion factor (REF + 36dB)	HALCHL HALCHR	SG62 SG4	−2dBm	1kHz				—	4, 62 = a	A	Pin 49 Pin 52	Measure the THD to the 10th	—	0.35	1.0	%
16	ALC effects (+36dB/+20dB)	VALCL23 VALCR23	SG62 SG4	−2dBm /−18dBm	1kHz				—	4, 62 = a	A	—	VALCL36/VALCL20 VALCR36/VALCR20	0.0	0.2	—	dB
17	E-E system maximum output level	VLNMXL VLNMXR	SG62 SG4	VAL	1kHz				—	1, 4, 62 = a	A	Pin 49 Pin 52	Output level when THD = 1%	—	—	0.5	dBm
18	FADER maximum attenuation	VFAL VFAR	SG62 SG4	−38dBm	1kHz				V3 = 2.5V	3, 4, 62 = a	A	Pin49 Pin 52	A weight	—	−74	−69	dBm
19	FADER dead voltage level	VFALOL VFALOR	SG62 SG4	−38dBm	1kHz				V3 = 0.5V	3, 4, 62 = a	A	Pin 49 Pin 52	VFALOL/VLNOL VFALOR/VLNOR	−0.5	0	0.5	dB
20	E-E system frequency response 1 (20kHz/1kHz)	FLNL20 FLNR20	SG62 SG4	−38dBm	20kHz /1kHz				—	4, 62 = a	A	Pin 49 Pin 52	FLNL20/VLNOL FLNR20/VLNOR	−3	−0.5	1	dB
21	E-E system frequency response 2 (50kHz/1kHz)	FLNL50 FLNR50	SG62 SG4	−38dBm	50kHz /1kHz				—	4, 62 = a	A	Pin 49 Pin 52	FLNL50/VLNOL FLNR50/VLNOR	—	−11	−5	dB
22	Input cross talk 1 between MIC and LINE	VCTL1 VCTR1	SG62 SG4	−28dBm	1kHz				—	4, 62 = a	G	Pin 49 Pin 52	Cross talk of MIC → LINE A weight	—	−71	−66	dBm
23	Input cross talk 2 between MIC and LINE	VCTL2 VCTR2	SG64 SG2	−28dBm	1kHz				—	2, 64 = a	A	Pin 49 Pin 52	Cross talk of LINE → MIC A weight	—	−71	−66	dBm
24	E-E system channel input cross talk 1	VCTLRL	SG62 SG4	−28dBm	1kHz				—	62 = a	A	Pin 52	Cross talk of L → R A weight	—	−73	−67	dBm
25	E-E system channel input cross talk 2	VCTLRR	SG4	−28dBm	1kHz				—	4 = a	A	Pin 49	Cross talk of R → L A weight	—	−73	−67	dBm
26	E-E system MUTE attenuation	VLNML VLNMR	SG62 SG4	−28dBm	1kHz				—	4, 62 = a	E	Pin 49 Pin 52	Output level during MUTE ON A weight	—	−90	−80	dBm
27	E-E system MUTE switching level output difference	VMDCL VMDCR							—		A/E	TP49 P52A	E-E system output DC level difference during MUTE ON/OFF.	−100	0	+100	mVp-p

No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measurement point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
28	NR encode reference output level	VNRL38 VNRR38	SG62 SG4	−38dBm	1kHz				—	4, 62 = a	H	Pin 37 Pin 15	BIL REC mode	−17	−15	−13	dBm
29	NR encode linearity (−78dBm/−38dBm)	VNRL78 VNRR78	SG62 SG4	−78dBm /−38dBm	1kHz				—	4, 62 = a	H	Pin 37 Pin 15	BIL REC mode VNRL78/VNRL38 VNRR78/VNRR38	−23	−22	−21	dB
30	NR encode frequency response during SP (10kHz/1kHz)	FNRL10 FNRR10	SG62 SG4	−38dBm	10kHz /1kHz				—	4, 62 = a	H	Pin 37 Pin 15	BIL REC mode FNRL10/VNRL38 FNRR10/VNRR38	3.7	4.9	5.8	dB
31	NR LP emphasis frequency response 1 during LP 2kHz (LP/SP)	FLPL2 FLPR2	SG62 SG4	−38dBm	2kHz				—	4, 62 = a	I/H	Pin 37 Pin 15	BIL REC mode Ratio of LP/SP	1	2	3	dB
32	NR LP emphasis frequency response 2 during LP 10kHz (LP/SP)	FLPL10 FLPR10	SG62 SG4	−38dBm	10kHz				—	4, 62 = a	I/H	Pin 37 Pin 15	BIL REC mode Ratio of LP/SP	2.5	3	3.5	dB
33	REC FM oscillation frequency 1.5MHz (NTSC)	FVCOL1	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24		1.4995	1.5	1.5005	MHz
34	REC FM oscillation frequency 1.7MHz (NTSC)	FVCOR1	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24		1.6995	1.7	1.7005	MHz
35	REC FM oscillation frequency 1.5MHz (PAL)	FVCOL2	SG29	200mVp-p	4.433619MHz				—	29 = a	D	Pin 24		1.4995	1.5	1.5005	MHz
36	REC FM oscillation frequency 1.7MHz (PAL)	FVCOR2	SG29	200mVp-p	4.433619MHz				—	29 = a	D	Pin 24		1.6995	1.7	1.7005	MHz
37	REC FM output level Lch (1.5MHz)	VFML	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24	Measure 1.5MHz carrier level	198	220	245	mVp-p
38	REC FM output secondary distortion Lch (1.5MHz)	VFMHL2	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24	More than 10kΩ load VFMHL2/VFML	—	−50	−25	dB
39	REC FM output ternary distortion Lch (1.5MHz)	VFMHL3	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24	More than 10kΩ load VFMHL3/VFML	—	−45	−30	dB

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No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measurement point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
40	REC FM output level Rch (1.7MHz)	VFMR	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24	Measure 1.7MHz carrier level	157	175	194	mVp-p
41	REC FM output secondary distortion Rch (1.7 MHz)	VFMHR2	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24	More than 10kΩ load VFMHR2/VFMR	—	−45	−25	dB
42	REC FM output ternary distortion Rch (1.7MHz)	VFMHR3	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24	More than 10kΩ load VFMHR3/VFMR	—	−45	−30	dB
43	REC FM output level L/R mix ratio	VCOMIX	SG29	200mVp-p	3.579545MHz				—	29 = a	A	Pin 24	Stereo VFML/VFMR	1.25	1.7	2.35	dB
44	BPF ADJ voltage	VBPAJ	SG22	15mVp-p	1.625MHz	SG29			V26 = VAL	22, 26, 29 = a 23 = a, b	B	TP26	Monitor Pin 23. Adjustment method noted separately.	0.1	—	2.9	V
45	BPF MONI level 1.5 MHz	VBPML	SG22	15mVp-p	1.5MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 26, 29 = a	B	Pin 23		137	194	274	mVp-p
46	BPF frequency response 0.8MHz/1.5MHz	FBPL08	SG22	15mVp-p	0.8MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 26, 29 = a	B	Pin 23	FBPL08/VBPML	—	−31	−28	dB
47	BPF frequency response 1.4MHz/1.5MHz	FBPL14	SG22	15mVp-p	1.4MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 26, 29 = a	B	Pin 23	FBPL14/VBPML	−6	−3	—	dB
48	BPF frequency response 1.6MHz/1.5MHz	FBPL16	SG22	15mVp-p	1.6MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 26, 29 = a	B	Pin 23	FBPL16/VBPML	−6	−3	—	dB
49	BPF frequency response 1.7MHz/1.5MHz	FBPL17	SG22	15mVp-p	1.7MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 26, 29 = a	B	Pin 23	FBPL17/VBPML	—	−20	−12	dB
50	BPF frequency response 2.5MHz/1.5MHz	FBPL25	SG22	15mVp-p	2.5MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 26, 29 = a	B	Pin 23	FBPL25/VBPML	—	−44	−28	dB
51	BPF MONI level 1.7MHz	VBPMR	SG22	12mVp-p	1.7MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 23, 26, 29 = a	B	Pin 23		137	210	290	mVp-p
52	BPF frequency response 1.5MHz/1.7MHz	FBPR15	SG22	12mVp-p	1.5MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 23, 26, 29 = a	B	Pin 23	FBPR15/VBPMR	—	−28	−23	dB
53	BPF frequency response 1.6MHz/1.7MHz	FBPR16	SG22	12mVp-p	1.6MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 23, 26, 29 = a	B	Pin 23	FBPR16/VBPMR	—	−15	−10	dB

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No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measurement point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
54	BPF frequency response 1.65MHz/1.7MHz	FBPR165	SG22	12mVp-p	1.65MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 23, 26, 29 = a	B	Pin 23	FBPR165/VBPMR	−6	−3	—	dB
55	BPF frequency response 1.75MHz/1.7MHz	FBPR175	SG22	12mVp-p	1.75MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 23, 26, 29 = a	B	Pin 23	FBPR175/VBPMR	−6	−3	—	dB
56	BPF frequency response 1.9MHz/1.7MHz	FBPL19	SG22	12mVp-p	1.9MHz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ	22, 23, 26, 29 = a	B	Pin 23	FBPR19/VBPMR	—	−29	−25	dB
57	DEV variable width 1.5M	VDEVL	SG62	−38dBm	400Hz	SG29	200mVp-p	3.579545MHz	V26 = VBPAJ V36 = VAL	26, 29, 36, 62 = a	H	TP36	BIL REC mode. Monitor Pin 24. Adjustment method noted separately.	0.1	—	2.9	V
58	DEV variable width 1.7M	VDEVR	SG4	−38dBm	400Hz	SG29	200mVp-p	3.579545MHz	V16 = VAL V26 = VBPAJ V36 = VDEVL	4, 16, 26, 29, 36 = a	H	TP16	BIL REC mode. Monitor Pin 24. Adjustment method noted separately.	0.1	—	2.9	V
59	AF LIM characteristics Lch	VAFLML	SG62	−2dBm	10kHz	SG29	200mVp-p	3.579545MHz	V16 = VDEVR V26 = VBPAJ V36 = VDEVL	16, 26, 29, 36, 62 = a	H	Pin 24	BIL REC mode maximum deviation width	84	100	116	±kHz
60	AF LIM characteristics Rch	VAFLMR	SG4	−2dBm	10kHz	SG29	200mVp-p	3.579545MHz	V16 = VDEVR V26 = VBPAJ V36 = VDEVL	4, 16, 26, 29, 36 = a	H	Pin 24	BIL REC mode maximum deviation width	42	50	58	±kHz
61	Reference FM modulation distortion factor Lch, Rch stereo	VRECHL VRECHR	SG62 SG4	−38dBm	1kHz	SG29	200mVp-p	3.579545MHz	V16 = VDEVR V26 = VBPAJ V36 = VDEVL	4, 16, 26, 29, 36, 62 = a	A	TP-P49 TP-P52	Measure the output of Pin 24 after demodulation at standard demodulator.	—	0.2	0.4	%
62	Output level during OA Lch stereo	VSLPL	SG-R62	−38dBm	1kHz	SG31 SG29	0 to 3V 200mVp-p	30Hz 3.579545MHz	V16 = VDEVR V26 = VBPAJ V36 = VDEVL	16, 26, 29, 31, 36 = a 22 = c	B	Pin 49	Use standard modulator	−9.0	−7.0	−5.0	dBm
63	Output distortion factor during OA Lch stereo	THBLPL	SG-R62	−38dBm	1kHz	SG31 SG29	0 to 3V 200mVp-p	30Hz 3.579545MHz	V16 = VDEVR V26 = VBPAJ V36 = VDEVL	16, 26, 29, 31, 36 = a 22 = c	B	Pin 49	Use standard modulator to the 10th THD	—	0.3	0.55	%
64	Output level during OA Rch stereo	VSLPR	SG-R4	−38dBm	1kHz	SG31 SG29	0 to 3V 200mVp-p	30Hz 3.579545MHz	V16 = VDEVR V26 = VBPAJ V36 = VDEVL	16, 26, 29, 31, 36 = a 22 = c	B	Pin 52	Use standard modulator	−9.0	−7.0	−5.0	dBm
65	Output distortion factor during OA Rch stereo	THBLPR	SG-R4	−38dBm	1kHz	SG31 SG29	0 to 3V 200mVp-p	30Hz 3.579545MHz	V16 = VDEVR V26 = VBPAJ V36 = VDEVL	16, 26, 29, 31, 36 = a 22 = c	B	Pin 52	Use standard modulator to 10th THD	—	0.15	0.55	%

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No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measurement point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
66	Output level during OA R/L difference	BBRP	SG-R62 / SG-R4	−38dBm	1kHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 26, 29, 31, 36 = a, 22 = c	B	Pin 49 / Pin 52	VSLPR/VSLPL	−1.5	0.0	+1.5	dB
67	Playback FM demodulation output noise Lch, Rch	VNLPL VNLPR	SG22	15mVp-p / 12mVp-p	1.5MHz / 1.7MHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 22, 26, 29, 31, 36 = a	J	Pin 49 / Pin 52	A weight	—	−79	−74	dBm
68	Playback system MUTE switching output level difference	VPBDCL VPBDCR	SG22	15mVp-p / 12mVp-p	1.5MHz / 1.7MHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 22, 26, 29, 31, 36 = a	B/F	TP49 / P52A	DC level difference during MUTE ON/OFF of playback line output	−100	—	+100	mVp-p
69	Separation during OA L → R stereo	SSRPR	SG-R62	−38dBm	400Hz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 26, 29, 31, 36 = a, 22 = c	B	Pin 52	L → R separation SSRPR/VSLPL Use standard modulator	—	−30	−26.5	dB
70	Separation during OA R → L stereo	SSRPL	SG-R4	−38dBm	400Hz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 26, 29, 31, 36 = a, 22 = c	B	Pin 49	R → L separation SSRPL/VSLPR Use standard modulator	—	−30	−26.5	dB
71	DOC detection sensitivity ON level	VDOCSL	SG22	See Fig. 1	1.5MHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL, V44, V46 = 2.4V	16, 22, 26, 29, 31, 36, 44, 46 = a	B	Pin 37	Value of Fig. 1-a when 15mVp-p is assumed 0dB	−15	−10	−7	dB
72	DOC detection sensitivity OFF level hysteresis width	VDOHSL	SG22	See Fig. 1	1.5MHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL, V44, V46 = 2.4V	16, 22, 26, 29, 31, 36, 44, 46 = a	B	Pin 37	Ratio of Fig. 1-b/ Fig. 1-a VDOHSL/VDOCSL	—	—	1	dB
73	ON level during DOC detection sensitivity LP	VDOCLL	SG22	See Fig. 1	1.5MHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL, V44, V46 = 2.4V	16, 22, 26, 29, 31, 36, 44, 46 = a	K	Pin 37	Value of Fig. 1-a when 15mVp-p is assumed 0dB	−17	−12	−9	dB
74	MUTE OFF DELAY T1	TMUON	SG22	See Fig. 2	Tone Burst	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 22, 26, 29, 31, 36 = a	J	Pin 49	Delay time from carrier lack to MUTE start T1 (during 680p)	1	1.36	1.7	ms
75	MUTE hold time T2	TMUOF	SG22	See Fig. 2	Tone Burst	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 22, 26, 29, 31, 36 = a	J	Pin 49	MUTE hold time during MUTE cancel T2	113	133	153	ms
76	PG doubler width Lch	TPGHL	See Fig. 3 SG22	15mVp-p	1.5MHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL, V44, V46 = 2.4V	16, 22, 26, 29, 31, 36, 44, 46 = a	J	Pin 37	Measure the T2 time of Fig. 3	6	8.4	10	μs

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No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measure-ment point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
77	PG doubler width Rch	TPGHR	See Fig. 3 / SG22	15mVp-p / 12mVp-p	1.5MHz / 1.7MHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL, V44, V46 = 2.4V	16, 22, 26, 29, 31, 36, 44, 46 = a	J	Pin 15	Measure T2 time of Fig. 3	10	12.2	14	μs
78	PG doubler delay Lch, Rch	TPGD	See Fig. 3 / SG22	15mVp-p / 12mVp-p	1.5MHz / 1.7MHz	SG31 / SG29	0 to 3V / 200mVp-p	30Hz / 3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL, V44, V46 = 2.4V	16, 22, 26, 29, 31, 36, 44, 46 = a	J	Pin 37 / Pin 15	Measure T1 time of Fig. 3	2	2.6	3.2	μs
79	Monaural auto detection ON level	AMOON	See Fig. 4 / SG22	15mVp-p / VAL	1.5MHz, fs = non, DEV = ±60kHz / 1.7MHz, fs = 1kHz, DEV = ±30kHz	SG29	200mVp-p	3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 22, 26, 29, 31, 36 = a	J	Pin 18 / Pin 22	Value of Fig. 4-a when 12mVp-p of 1.7M component is set to 0dB	−12	−9	−5.3	dB
80	Monaural auto detection OFF hysteresis width	AMOOFF	See Fig. 4 / SG22	15mVp-p / VAL	1.5MHz, fs = non, DEV = ±60kHz / 1.7MHz, fs = 1kHz, DEV = ±30kHz	SG29	200mVp-p	3.579545MHz	V16 = VDEVR, V26 = VBPAJ, V36 = VDEVL	16, 22, 26, 29, 31, 36 = a	J	Pin 18 / Pin 22	Value of Fig. 4-b when 12mVp-p of 1.7M component is set to 0dB	—	—	1	dB
81	CS, CK and SIN input low level	VSIL	58, 59, 60	VAL	DC				—		—	Pins 58, 59, 60	Confirm all mode switching shown in the mode table	0	—	1	V
82	CS, CK and SIN input high level	VSIH	58, 59, 60	VAL	DC				—		—	Pins 58, 59, 60	Confirm all mode switching shown in the mode table	2	—	Vcc	V
83	Serial/parallel low level (parallel)	V17SL	17	VAL	DC				—		—	Pin 17	Parallel	0	—	3.5	V
84	Serial/parallel high level (serial)	V17SH	17	VAL	DC				—		—	Pin 17	Serial	4.3	—	VccH	V
85	SP/$\overline{LP}$ low level (LP)	V17L	17	VAL	DC				—		—	Pin 17	Parallel mode check LP	0	—	1	V
86	SP/$\overline{LP}$ high level (SP)	V17H	17	VAL	DC				—		—	Pin 17	Parallel mode check SP	2	—	3.5	V
87	NTSC/$\overline{PAL}$ low level (PAL)	V28L	28	VAL	DC				—		—	Pin 28	Parallel mode check PAL	0	—	1	V
88	NTSC/$\overline{PAL}$ high level (NTSC)	V28H	28	VAL	DC				—		—	Pin 28	Parallel mode check NTSC	2	—	Vcc	V
89	Recording system MATRIX low level (MONO)	V32L	32	VAL	DC				—		—	Pin 32	Parallel mode check monaural	0	—	0.7	V

No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measurement point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
90	Recording system MATRIX high level (STEREO)	V32H	32	VAL	DC				—		—	Pin 32	Parallel mode check stereo	2.3	—	Vcc	V
91	Playback system MATRIX low level (BIL/MONO auto)	V32PBL	32	VAL	DC				—		—	Pin 32	Parallel mode check BIL/monaural auto	0	—	0.7	V
92	Playback system MATRIX middle level (ST/MONO auto)	V32PBM	32	VAL	DC				—		—	Pin 32	Parallel mode check stereo/monaural auto	1.3	—	1.7	V
93	Playback system MATRIX high level (forced STEREO)	V32PBH	32	VAL	DC				—		—	Pin 32	Parallel mode check forced stereo	2.3	—	Vcc	V
94	E-E system output switching low level (L/R)	V33L	33	VAL	DC				—		—	Pin 33	Parallel mode check MAIN/SUB (L/R)	0	—	0.7	V
95	E-E system output switching middle level (L/L)	V33M	33	VAL	DC				—		—	Pin 33	Parallel mode check MAIN/MAIN (L/L)	1.3	—	1.7	V
96	E-E system output switching high level (R/R)	V33H	33	VAL	DC				—		—	Pin 33	Parallel mode check SUB/SUB (R/R)	2.3	—	3.5	V
97	BPF through switching high level 2 (BPF OFF)	V33H2	33	VAL	DC				—		—	Pin 33	Parallel mode check BPF through (OFF)/POWER SAVE ON	4.3	—	VccH	V
98	MUTE ON/OFF low level (MUTE OFF)	V48L	48	VAL	DC				—		—	Pin 48	Parallel mode check MUTE OFF	0	—	1	V
99	MUTE ON/OFF high level (MUTE ON)	V48H	48	VAL	DC				—		—	Pin 48	Parallel mode check MUTE ON	2	—	Vcc	V
100	MIC/LINE low level (LINE)	V58L	58	VAL	DC				—		—	Pin 58	Parallel mode check LINE	0	—	1	V
101	MIC/LINE high level (MIC)	V58H	58	VAL	DC				—		—	Pin 58	Parallel mode check MIC	2	—	Vcc	V
102	PB/REC low level (REC)	V59L	59	VAL	DC				—		—	Pin 59	Parallel mode check REC	0	—	1	V
103	PB/REC high level (PB)	V59H	59	VAL	DC				—		—	Pin 59	Parallel mode check PB	2	—	Vcc	V

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No.	Item	Symbol	Measurement input signal conditions			Reference signal source			Control voltage	Switch condition	Mode condition	Measurement point	Measurement method	Min.	Typ.	Max.	Unit
			Input pin	Level	Frequency	Input pin	Level	Frequency									
104	LINEOUT MIX ON/OFF low level (MIX OFF)	V60L	60	VAL	DC				—		—	Pin 60	Parallel mode check LINE Lch MIX OFF	0	—	1	V
105	LINEOUT MIX ON/OFF high level (MIX ON)	V60H	60	VAL	DC				—		—	Pin 60	Parallel mode check LINE Lch MIX ON	2	—	V_{CC}	V

* fsc recommended input level is normally 200mVp-p and the recommended input range is 100mVp-p to 1000mVp-p.

Mode Condition Table
Electrical Characteristics Measurement Circuit Mode Table

Mode condition	Mode contents	bit 0 to 4 (—)	bit 5 P.SAVE	bit 6 MAT RIX2	bit 7 MAT RIX1	bit 8 OUT SEL2	bit 9 OUT SEL1	bit 10 MIX	bit 11 LINE/MIC	bit 12 LP/SP	bit 13 PAL/NTSC	bit 14 MUTE	bit 15 REC/PB	V17 LP/SP	V20 BIL/—	V28 PAL/NTSC	V32 MAT RIX	V33 OUT SEL	V48 MUTE	V58 LINE/MIC	V59 REC/PB	V60 MIX
A	REC		0	1	1	0	0	0	1	1	1	0	0	H	OPEN	H	H	L	L	H	L	L
B	PB		0	1	1	0	0	0	1	1	1	0	1	H	OPEN	H	H	L	L	H	H	L
C	REC/LP		0	1	1	0	0	0	1	0	1	0	0	L	OPEN	H	H	L	L	H	L	L
D	REC/PAL		0	1	1	0	0	0	1	1	0	0	0	H	OPEN	L	H	L	L	H	L	L
E	REC/MUTE		0	1	1	0	0	0	1	1	1	1	0	H	OPEN	H	H	L	H	H	L	L
F	PB/MUTE		0	1	1	0	0	0	1	1	1	1	1	H	OPEN	H	H	L	H	H	H	L
G	REC/LINE		0	1	1	0	0	0	0	1	1	0	0	H	OPEN	H	H	L	L	L	L	L
H	REC/BIL		0	1	0	0	0	0	1	1	1	0	0	H	L	H	L	L	L	H	L	L
I	REC/BIL/LP		0	1	0	0	0	0	1	0	1	0	0	L	L	H	L	L	L	H	L	L
J	PB/BIL		0	0	0	0	0	0	1	1	1	0	1	H	OPEN	H	L	L	L	H	H	L
K	PB/LP		0	1	1	0	0	0	1	0	1	0	1	L	OPEN	H	H	L	L	H	H	L
L																						
M																						
N																						
O																						

BUS DECODER condition table during serial · Condition table during parallel

* During serial control, set switches 58, 59 and 60 to "a", and V17 to 4.3V to VccH.
During parallel control, set switches 58, 59 and 60 to "b", and set according to the mode table.

L: 0 to 1V
M: 1.3 to 1.7V
H: 2 to 3.5V
H2: 4.3V to VccH

Mode Control Tables

1. Parallel CTL mode table

| Pin No.	Symbol		LOW (0 to 1V)	OPEN	HIGH1 (2V to Vcc)	HIGH2 (2V to 3.5V)	HIGH3 (4.3V to VccH)	Remarks
17	SP/ LP		LP	SP	—	SP	Serial mode [1]	
20	REC BIL CTL	REC	BIL REC (during Pin 32 low)	—	—	—	—	CTL IN during REC
	PB MONODET OUT	PB	STEREO/ BIL	MONO	—	—	—	DET OUT during PB
28	NTSC/PAL		PAL	—	NTSC	—	—	
32	MATRIX CTL	REC	Forced MONO	STEREO	STEREO	—	—	
		PB	Bilingual/ MONO auto detection	STEREO/ MONO auto detection	Forced STEREO	—	—	
33	OUTSEL CTL		Lch/Rch	Lch/Lch	—	Rch/Rch	—	
	POWER SAVE		OFF	OFF	—	OFF	ON	
	BPF ON/OFF		ON	ON	—	ON	OFF (only 1.5M BPF is through)	
48	MUTE		MUTE OFF	MUTE ON	MUTE ON	—	—	
58	MIC/LINE		LINE	LINE	MIC	—	—	
59	REC/PB		REC	REC	PB	—	—	
60	RFU (MIX)		OFF	OFF	ON	—	—	

[1] When Pin 17 is 4.3V or more, the IC operates in serial control mode.

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2. Serial control

* When Pin 17 is 4.3V or more, the IC operates in serial control mode.

1) Input condition

Item	Symbol	Min.	Typ.	Max.	Unit
Clock frequency	fck			800	kHz
Setup time	t_{SU}	400			ns
Hold time	t_{HLD}	400			ns
CS rise time to SI start time	t1	2			μs
Final CS rise time to CS fall time	t2	2			μs

Pin No.	Symbol	CTL voltage LOW (0 to 1V)	OPEN	HIGH (2V to Vcc)
58	CS	L	L	H
59	CK	L	L	H
60	SIN	L	L	H
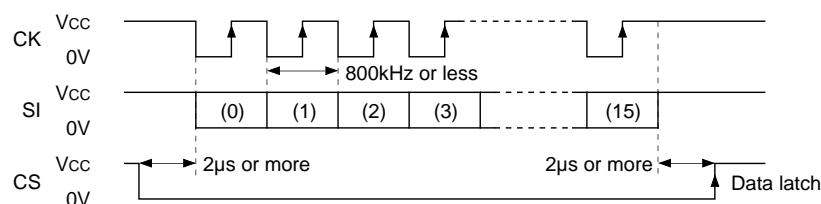
2) Serial CTL mode table

Bit No.	Control name	CTL value	Mode
0	—	L	—
1	—	L	—
2	—	L	—
3	—	L	—
4	—	L	—
5	POWER SAVE	L H	OFF ON
6	MATRIX2	See Table 1	See Table 1
7	MATRIX1	See Table 1	See Table 1
8	OUTSEL2	See Table 2	See Table 2
9	OUTSEL1	See Table 2	See Table 2
10	LINEOUT MIX	L H	OFF ON
11	LINE/MIC switching	L H	LINE MIC
12	LP/SP switching	L H	LP SP
13	PAL/NTSC switching	L H	PAL NTSC
14	MUTE	L H	OFF ON
15	REC/PB switching	L H	REC PB

Table 1

OUTSEL1 (bit 9)	OUTSEL2 (bit 8)	
H	H	Rch/Rch
L	H	Lch/Lch
—	L	Lch/Rch

Table 2

| MATRIX1 (bit 7)	MATRIX2 (bit 6)	during REC	during PB
H	L	MATRIX ON	MATRIX ON
H	H	MATRIX ON	MATRIX (AUTO)
L	H	BIL REC	MATRIX (AUTO)
L	L	REC MONO	MATRIX OFF BIL/MONO (AUTO)

3) SO control mode table

Mode (only the shaded period as shown in the figure right)		Pin 20 (SO)
REC	During Pin 32 = L	OPEN
	During Pin 32 = H	L
PB	$\overline{\text{MONO}}$	L
	MONO	OPEN

CS
58Pin

SO
20Pin   H or OPEN   H or OPEN
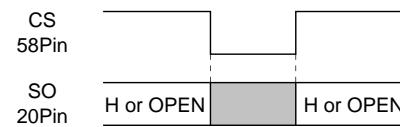
The result of detection is output during CS period.
H or OPEN other than CS period.

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I/O Waveform

Pin 22 input waveform   b a

Level when the 1.5MHz signal is AM modulated (2mVp-p to 20mVp-p) at 1kHz and the 15mVp-p input is set to 0dB.

Pin 37 output waveform

Fig. 1

1ms   200ms   1.5MHz Dev = ±60kHz fs = 1kHz

Pin 22 input waveform   15mVp-p

T1   T2

Pin 49 output waveform

Fig. 2

Pin 31 input waveform

Pin 37 output waveform
Pin 15 output waveform

T1 PGD delay   T2 PGD width

Fig. 3

1.7M component waveform
VAL/1.7MHz/AM = 100%/fs = 400Hz

1.5M component waveform
15mVp-p/1.5MHz/SIN wave

Pin 22 input waveform   b a

Pin 18 output waveform

Level when the 1.7MHz signal is AM modulated (2mVp-p to 20mVp-p) at 400Hz and the 12mVp-p input is set to 0dB.

Fig. 4

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Adjustment and Measurement Methods

DEV adjustment method
• Lch adjustment
Input the reference input (–38dBm/400Hz) to the MIC input (Pin 62) and adjust the voltage applied to Pin 36 (V36) so that the Pin 24 output reference frequency deflection is 1.5MHz ± 60kHz.
When adjusting DEV, connect a 10kΩ load resistor between Pin 24 and GND as shown in the electrical characteristics measurement circuit.
• Rch adjustment
Input the reference input (–38dBm/400Hz) to the MIC input (Pin 4) and adjust the voltage applied to Pin 16 (V16) so that the Pin 24 output reference frequency deflection is 1.7MHz ± 30kHz.
When adjusting DEV, connect a 10kΩ load resistor between Pin 24 and GND as shown in the electrical characteristics measurement circuit.

Reference FM modulation distortion factor measuring method
Demodulate the Pin 24 output into the audio signal with the reference demodulator under the same conditions as for DEV adjustment above, then measure the distortion factor.

BPF adjustment method
Input 15mVp-p, 1.625MHz signal to Pin 22 and adjust the voltage applied to Pin 26 (V26) so that the output level when the SW of Pin 23 is switched to "a" (1.7M BPF output) and the output level when the SW of Pin 23 is switched to "b" (1.5M BPF output) are equal.
When adjusting BPF, connect a 4.7kΩ load resistor between Pin 23 and GND as shown in the electrical characteristics measurement circuit.

Fader adjustment method
Input the reference input (–38dBm/ 400Hz) to the MIC input (Pins 62 and 4) and adjust the output level of Pins 49 and 52 with the voltage applied to Pin 3 (V3).

Electrical Characteristics Measurement Circuit

Application Circuit
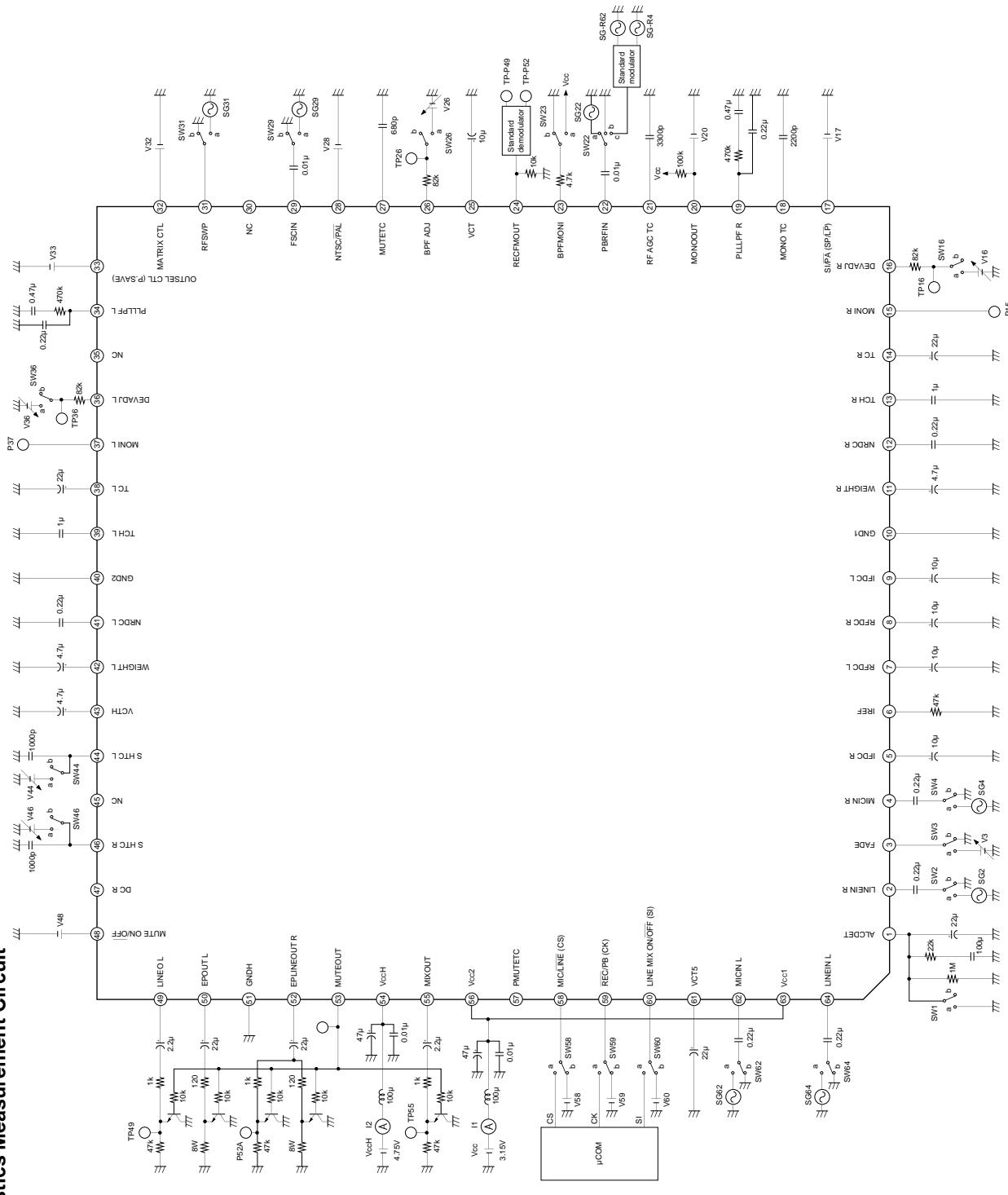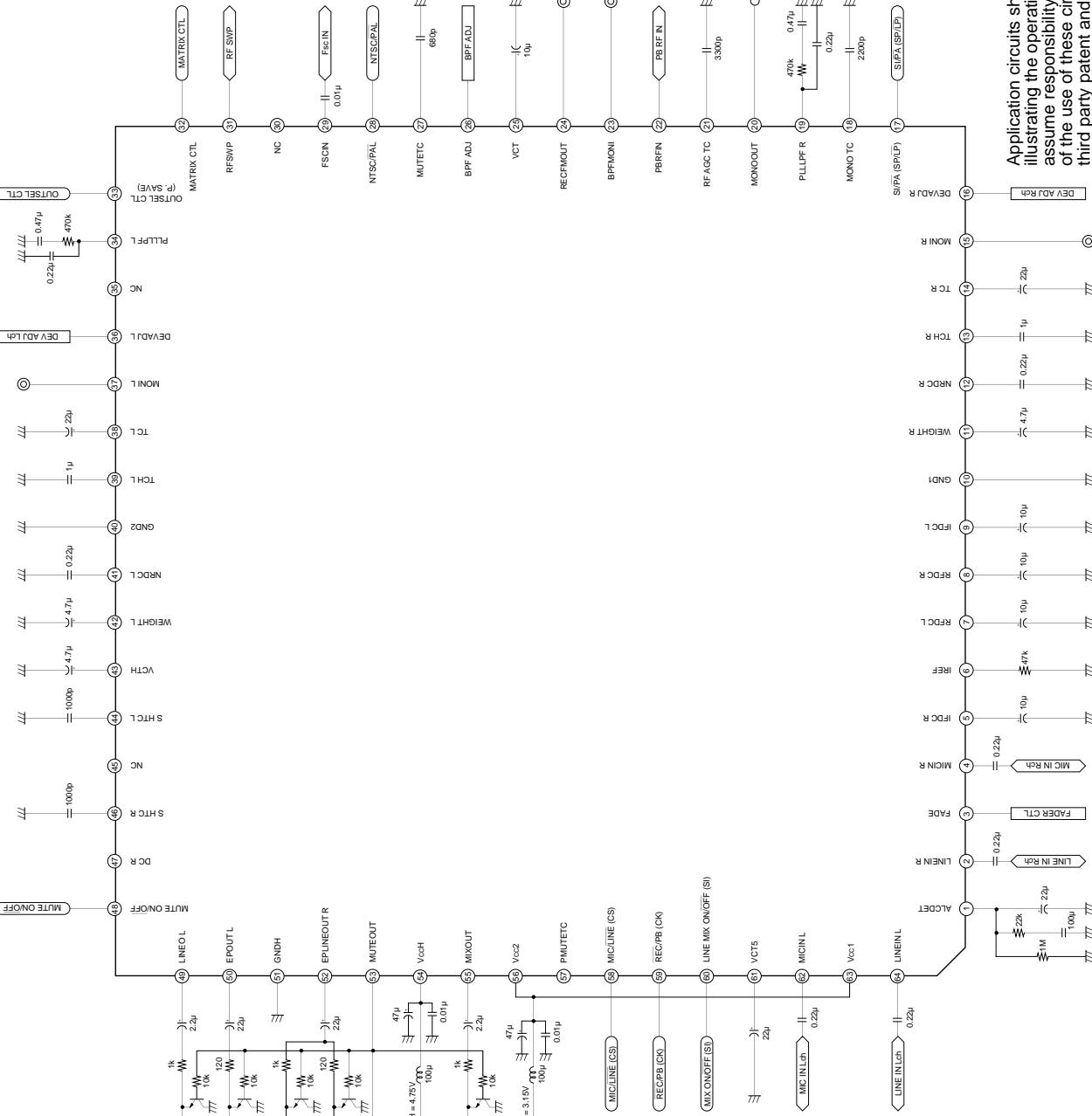
Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

Graph 1. FADER control characteristics

Pins 49 and 52 output level [dBm] vs Pin 3 adjustment voltage [V]
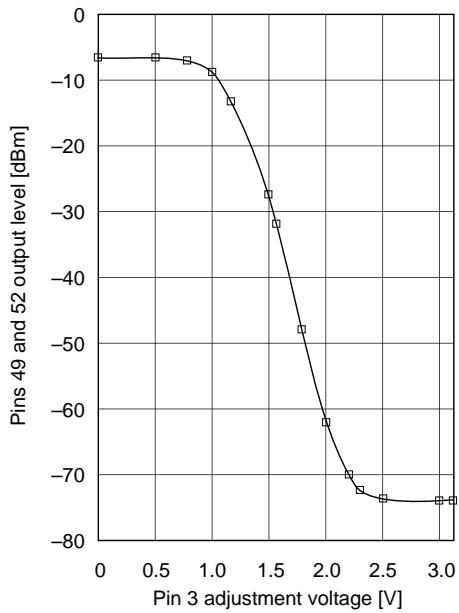
Graph 2. BPF ADJ control characteristics

1.5M/1.7M BPF cross frequency [MHz] vs TP26 adjustment voltage [V]

26 —/\/\/\— TP26
82k
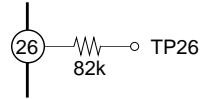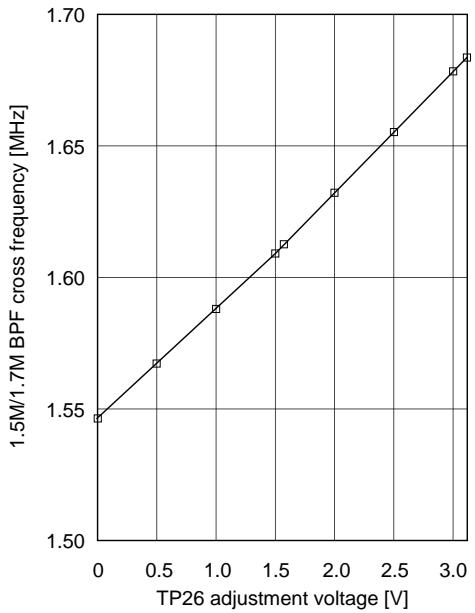
Graph 3. DEV ADJ control characteristics Lch

1.5M side DEV width [±kHz] vs TP36 adjustment voltage [V]

36 —/\/\/\— TP36
82k
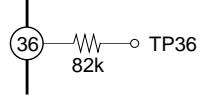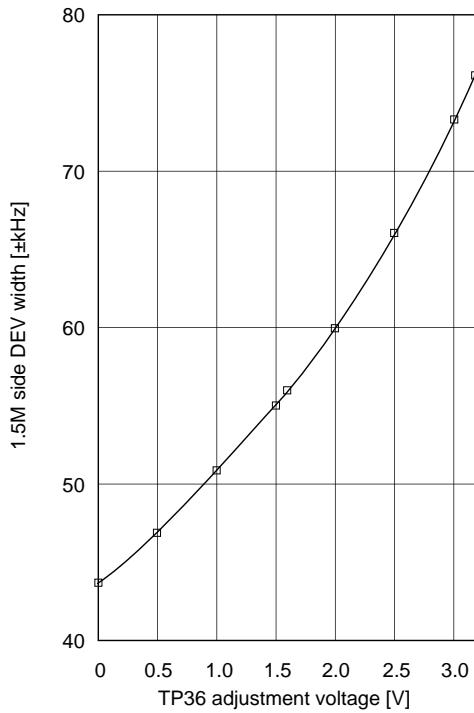
Graph 4. DEV ADJ control characteristics Rch

1.7M side DEV width [±kHz] vs TP16 adjustment voltage [V]

16 —/\/\/\— TP16
82k

– 35 –
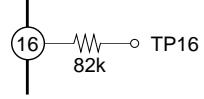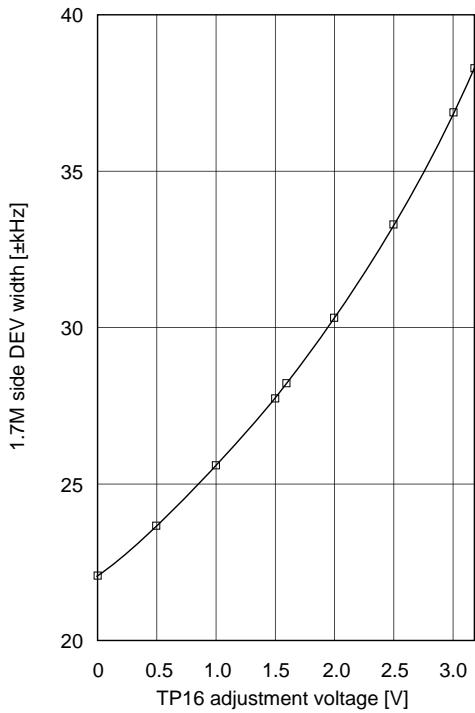
Package Outline　　Unit: mm

64PIN LQFP (PLASTIC)

□12.0 ± 0.2

∗□ 10.0 ± 0.1

48　　33

49　　32

64　　17
(0.22)

1　　16

0.5 ± 0.08

0.18 − 0.03 + 0.08

(11.0)

0.5 ± 0.2

0.127 − 0.02 + 0.05

1.5 − 0.1 + 0.2

0.1

A

0.1 ± 0.1

0.5 ± 0.2

0° to 10°
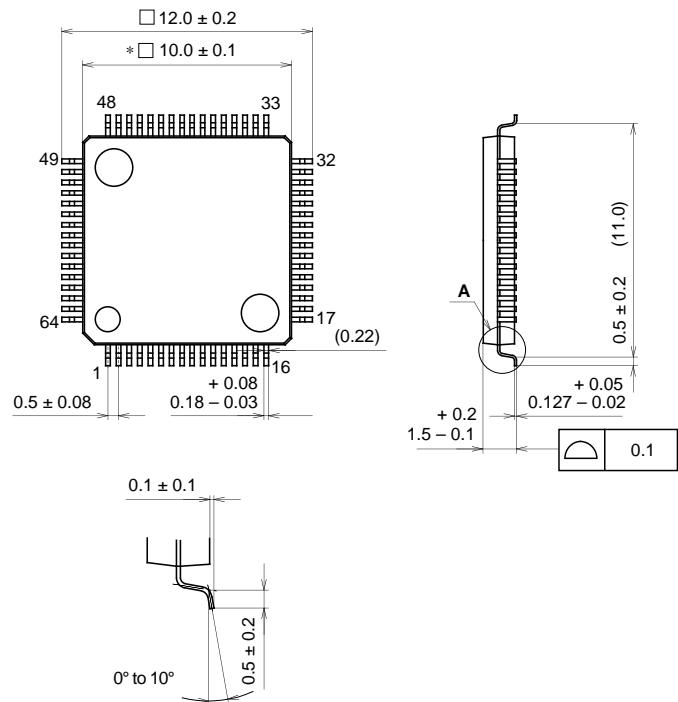
DETAIL **A**

NOTE: Dimension "∗" does not include mold protrusion.

SONY CODE	LQFP-64P-L01
EIAJ CODE	LQFP064-P-1010
JEDEC CODE	————

PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER/PALLADIUM PLATING
LEAD MATERIAL	42/COPPER ALLOY
PACKAGE MASS	0.3g